PRELIMINARY SPEC

Part Number: APT3216VGC/Z Green

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Features

- 3.2mmx1.6mm SMT LED, 0.75mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.

Description

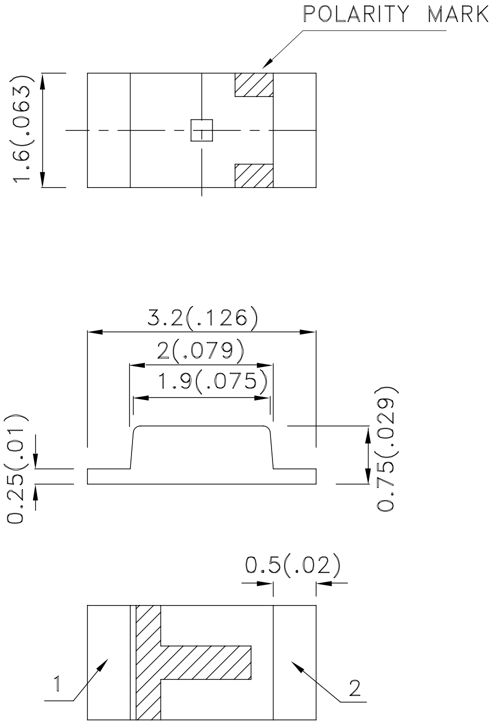
The Green source color devices are made with InGaN Light Emitting Diode.

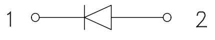
Static electricity and surge damage the LEDS.

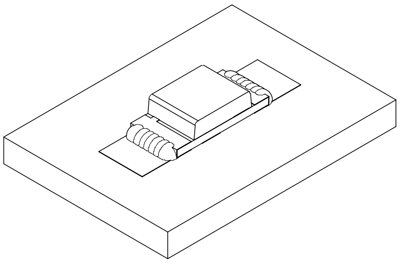
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions







1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.2(0.008") unless otherwise noted.
3. Specifications are subject to change without notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
APT3216VGC/Z	Green (InGaN)	WATER CLEAR	380	800	120°

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

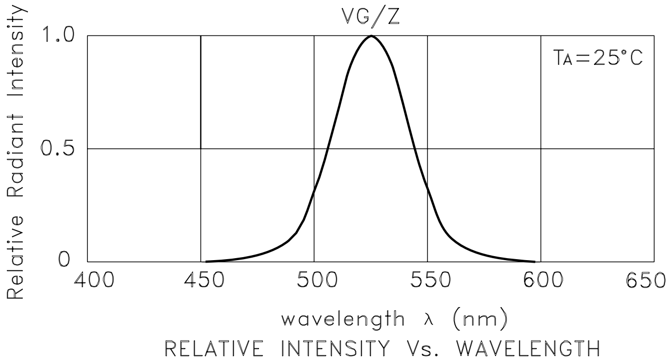
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	525		nm	I_F=20mA
λD [1]	Dominant Wavelength	Green	535		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	Green	39		nm	I_F=20mA
C	Capacitance	Green	65		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	Green	3.2	3.7	V	I_F=20mA
I_R	Reverse Current	Green		10	uA	V_R=5V

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

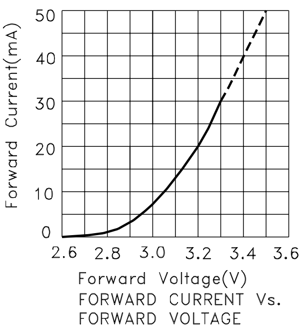
Absolute Maximum Ratings at TA=25°C

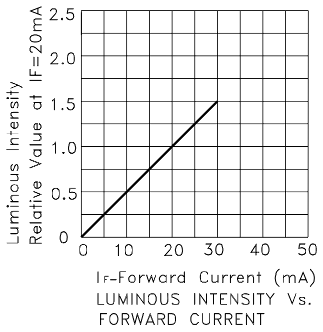
Parameter	Green	Units
Power dissipation	111	mW
DC Forward Current	30	mA
Peak Forward Current [1]	100	mA
Reverse Voltage	5	V
Operating Temperature	-40°C To +85°C	
Storage Temperature	-40°C To +85°C	

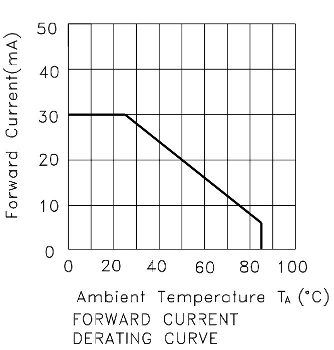
Note:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

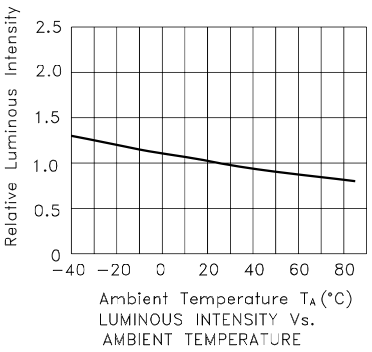


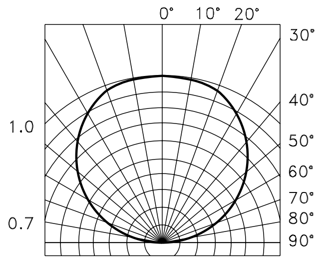
Green **APT3216VGC/Z**





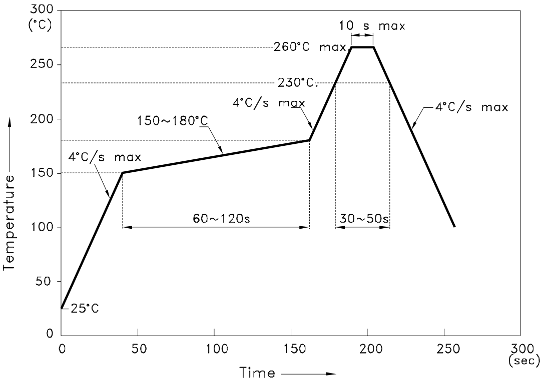






SPATIAL DISTRIBUTION

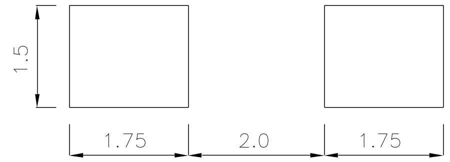
Reflow Soldering Profile For Lead-free SMT Process.



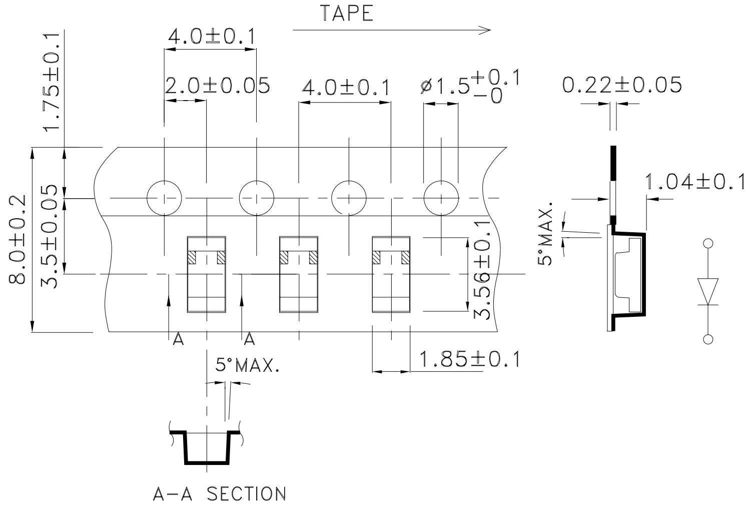
NOTES:

1. We recommend the reflow temperature 245°C(+/−5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

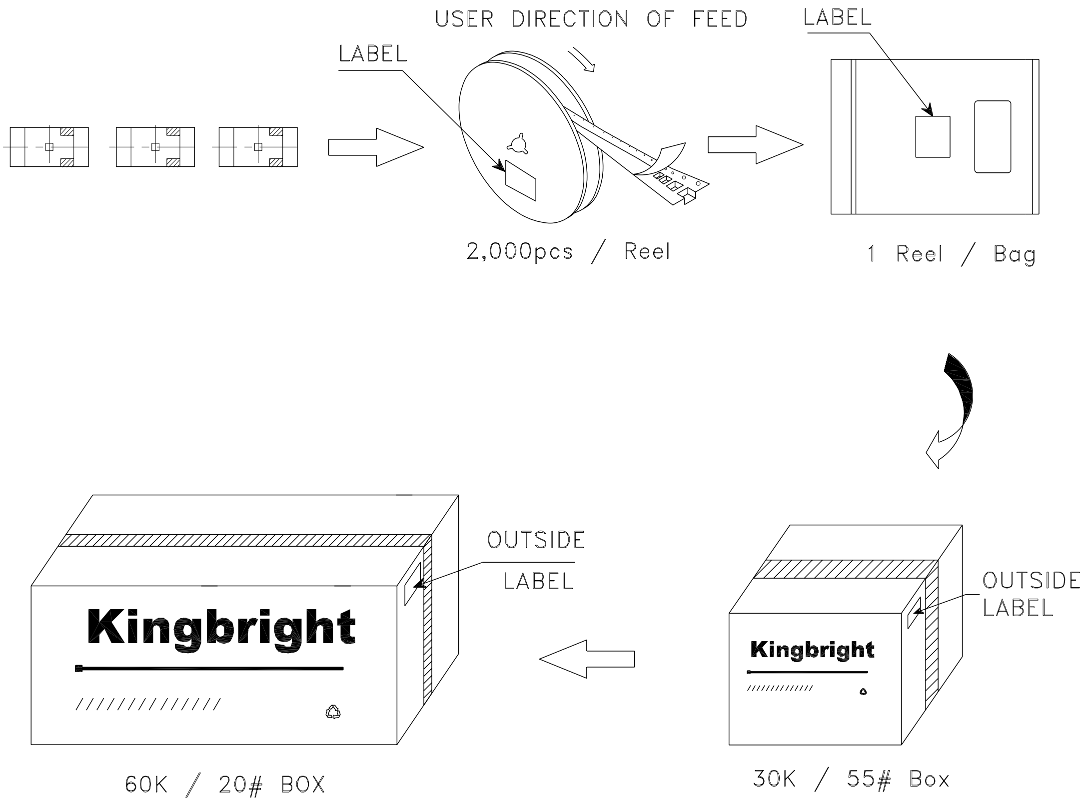
Recommended Soldering Pattern
(Units : mm; Tolerance: ± 0.1)

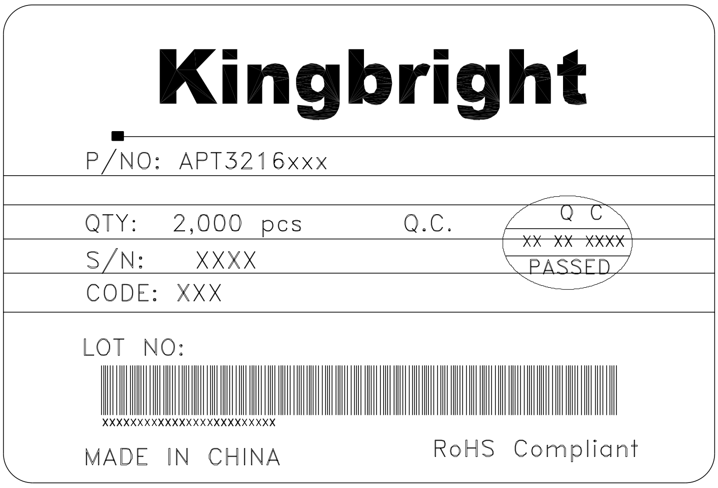


Tape Specifications
(Units : mm)



PACKING & LABEL SPECIFICATIONS **APT3216VGC/Z**





Kingbright

P/NO: APT3216xxx

QTY: 2,000 pcs Q.C. Q C XX XX XXXX PASSED

S/N: XXXX

CODE: XXX

LOT NO:

XXXXXXXXXXXXXXXXXXXXXXXXXX

MADE IN CHINA RoHS Compliant